

Title (en)

Method for increasing the hydrophilicity of polymeric materials

Title (de)

Verfahren zum Steigern der Hydrophilie polymerer Materialien

Title (fr)

Procédé d'augmentation de l'hydrophilie des matériaux polymériques

Publication

**EP 2559806 A1 20130220 (EN)**

Application

**EP 11006735 A 20110817**

Priority

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Abstract (en)

A method for increasing the hydrophilicity of a fibrous or porous polymeric material in a sample comprising said polymeric material, comprises contacting said sample with an oxidizing gas comprising an oxidizing component.

IPC 8 full level

**D06L 3/02** (2006.01); **D06L 3/04** (2006.01); **D06L 4/50** (2017.01); **D06M 11/32** (2006.01); **D06M 11/34** (2006.01)

CPC (source: EP)

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